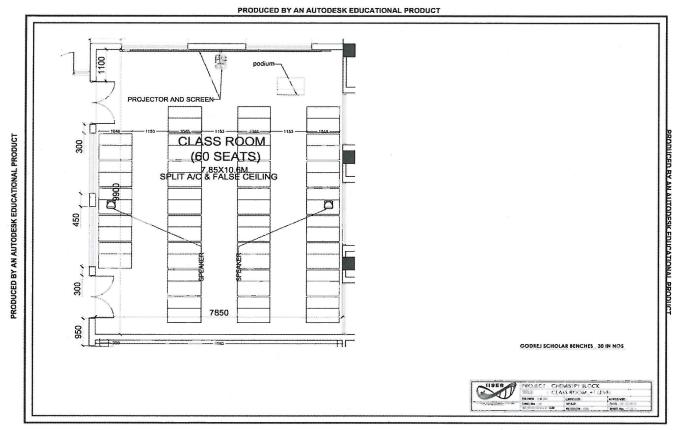
Appendix E

60 seat class room



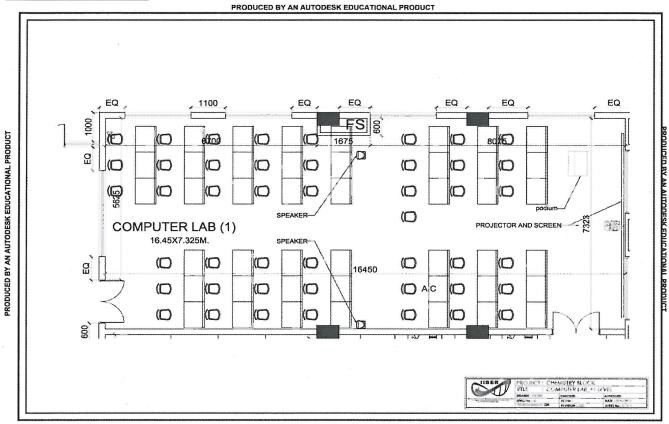
PRODUCED BY AN AUTODESK EDUCATIONAL PRODUCT

के. भास्कर राव/K. BHASKARA RAO
उप कुलसचिव [क्रय एवं भंजार]
Deputy Registrar [Purchase & Stores]
भारतीय विज्ञान शिक्षा एंव अनुसंज्ञान सरकान हिम्मानन्तपुरम
Indian Institute of Science Education and Research Internatible

Gen campus, Enganosaga and Generally रन/Thiruvananthapuram-695 016

Appendix F

54 seat computer lab



PRODUCED BY AN AUTODESK EDUCATIONAL PRODUCT

के. भास्कर राव/K. BHASKARA RAO उप कुलसचिव [क्रय एवं भंडार] Deputy Registrar [Purchase & Stores]

पारतीय विज्ञान शिक्षा एंव अनुरांधान संस्थान तिस्वनन्तपुरम Indian Institute of Science Education and Research Thiruvananthapuram सी.ई.टी कैम्पस, इंजीनीयरींग कोलेज पी.ओ CET Campus, Engg. College P.O. तिरुवनन्तपुरम/Thiruvananthapuram-695 016

Appendix G

Console table

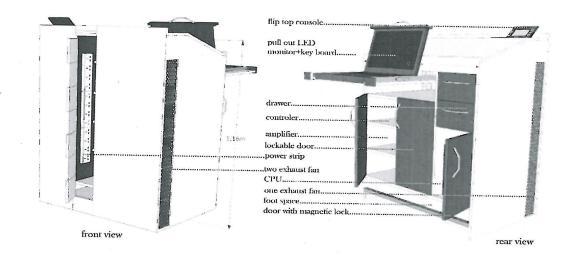


Chart Charles and Charles and

के. भास्कर राव/K. BHASKARA RAO उप कुलसचिव [क्रय एवं भंडार] Deputy Registrar [Purchase & Stores] भारतीय विज्ञान शिक्षा एवं अनुसंधान संस्थान तिरुवनन्तपुरम Indian Institute of Science Education and Ressarch Thiruvananthapuram सी.ई.टी कैप्पस, इंजीनीयपी कोलेज पी.ओ CET Campus, Engg. College P.O. तिरुवनन्तपुरम/Thiruvananthapuram-695 016

III. RHEOMETER WITH ACCESSORIES- 1 No

1. IFT No. : IISER/PUR/6517/15

2. Due Date : 21st April 2016 [4 PM]

3. Date of Opening of : 22nd April2016 [3 PM]

TECHNICAL BID

4. DATE OF OPENING OF PRICE: Will be notified later.

BID

5. COST OF TENDER# : Rs. 500 + 5% VAT

6. EMD [BID SECURITY] ** : Rs. 1,70,000/-

UNIVERSAL RHEOMETER SYSTEM

MAIN INSTRUMENT

MEASURING HEAD TYPE	A/c or D/c Type
TORQUE RANGE	0.5nNm to 200mNm OR BETTER
MOTOR BEARING	DUAL AIR BEARING
SPEED RANGE	10E-7 to 300 rad/s OR BETTER
	DIGITAL CURRENT SOURCE WITH HIGH SPEED DIGITAL
MOTOR CONTROL	SIGNAL PROCESSING
FREQUENCY RANGE	10E-7to 600 rad/s OR BETTER
STRAIN SENSOR	HIGH RESOLUTION OPTICAL ENCODER
	DIRECT STRAIN AMPLITUDE AND DIRECT STRESS
MODES	AMPLITUDE
MEASUREMENT TYPES	ROTATIONAL, OSCILLATORY & TRANSIENT
OSCILLATORY MODES	DIRECT STRAIN AMPLITUDE & CONTROL STRESS
NORMAL FORCE	0.05 to 50N OR BETTER
GAP CONTROL	
(STANDARD)	AUTOMATIC GAP COMPENSATION
2	SCREWLESS QUICK FITTING WITH WIRELESS
MEASURING SYSTEM	AUTOMATIC IDENTIFICATION OF MEASURING
CONNECTION	GEOMETRIES
	AUTOMATED ELECTRONIC TRIMLOCK DURING SAMPLE
SAMPLE LOADING	LOADING AND SAMPLE TRIMMING
	DIRECT USB INTEFACE, ETHERNET AND SERIAL
PC INTERFACES	INTERFACE

INTERFACIAL RHEOLOGY SYSTEM

	INTERFACIAL RHEOLOGY CELL WITH GLASS CYLINDER
	MEASURING SYSTEM: BICONE GEOMETRY
	SOFTWARE: AUTOMATIC MEASUREMENT OF
	INTERFACIAL MODULI AND VISCOSITY
	TEMPERATURE RANGE FOR INTERFACIAL RHEOLOGY: 5
	TO 70 DEGC
	PELTIER TEMPERATURE CONTROLLER: -20C TO 200C
	PELTIER DEVICE. (THIS TEMPERATURE CONTROLLER IS
INTERFACIAL	TO BE USED WITH PARALELL PLATES/CONE & PLATES
MEASURING SYSTEMS	MEASURING GEOMETRIES ALSO)

RHEO-OPTICS: RHEOMICROSCOPY

el.

TEMPERATURE	TRANSPARENT PELTIER PLATE SYSTEM FOR CONE/PLATE
CONTROL	(COMMON FOR RHEO-MICROSCOPE/RHEO-SALS/UV CURING
PELTIER	
TEMPERATURE	
RANGE	-10 TO 200C OR BETTER
MAX HEATING	
RATE	20 C/min OR BETTER
MAX COOLING	
RATE	18C/min OR BETTER
MICROSCOPE SETUP	BRIGHTFIELD SETUP WITH SAME SIDE ILLUMINATION
COOL SHADOW FRE	
ILLUMINATION,	
LAMP TYPE	150 WATT
LENSE SYSTEM	20X OBJECTIVE and 2X EYPIECE OR BETTER
DEPTH OF FOCUS	1.6 MICRO METER OR BETTER
CAPTURING/RECOR	
DING CAMERA	1/3" CCD CAMERA, At least 15 frames/s
	COOL SHADOW FREE ILLUMINATION FROM 150W VISIBLE
LIGHT SOURCE	LIGHT SOURCE
	THE RHEOMETER SHOULD BE UPGRADABLE FOR SMALL
	ANGLE LIGHT SCATTERING SYSTEMS (SALS) USING THE SAME
	TEMPERATURE CONTROLLER & SOFTWARE. ANY SET-UP WITH
	DIGITAL MAGNIFICATION WILL NOT BE ACCEPTABLE.

SMALL ANGLE LIGHT SCATTERING SYSTEMS (SALS)

	TRANSMISSION MODE SETUP WITH DIRECT TRANSFER OF
SALS SETUP	SCATTERED INTENSITIES ON THE CCD CHIP
SALS SETUP	
	TELECENTRIC OPTICS FOR MINIMAL LOSS OF SCATTERED
OPTICS	INTENSITY SIGNAL
SCATERRING ANGLE	
RANGE	1 TO 25 DEGREE
SCATTERING VECTOR	
RANGE	0.17 TO 4.17 1/MICRON
CAPTURING/RECORDING	
CAMERA	1/3" CCD CAMERA (COMMON WITH RHEO-MICROSCOPY)
LASER SOURCE	390 MICRO WATT LED AT 658nm WAVELENGTH
	TRANSPARENT PARALLEL PLATE AND TRANSPARENT
MEASURING SYSTEM	CONE
PELTIER TEMPERATURE	
CONTROLLER	-10 TO 200 DEG C (COMMON WITH RHEO-MICROSCOPY)
	REQUIRED ANALYSIS SOFTWRAE FOR THE ANALAYSIS
ANALYSIS SOFTWRE	OF SCATTERING PATTERN SHOULD BE QUOTED

MEASURING SYSTEMS COMPATIBLE WITH PELTIER TEMPERARURE CONTROL , HIGH TEMPERATURE FURNACE AND HUMIDITY CONTROLLER. SOLVENT TRAP SHOULD INVARIABLY BE QUOTED .

	PARALELL PLATE with DIAMETER 25MM -01 NO.
	PARALELL PLATE with DIAMETER 50 MM -01 NO.
	CONE WITH 25 MM DIA WITH 2 DEG ANGLE -01 NO.
	CONE WITH 50 MM DIA & 1 DEG ANGLE-01NO.
	PROFILED UPPER & LOWER PLATES WITH
	DIAMETER:25MM (ONE EACH)
SHEAR	, ,
VISCOMETRY/RHEOLOGY	DISPOSABLE MEASURING GEOMETRIES:

chit.

	•	PARALELL PLATE with DIAMETER 25MM -50 NO.
1		LOWER PARALELL PLATE with DIAMETER 25MM -50
		NO.
		LOWER PARALELL PLATE with DIAMETER 25MM -50 NO
		FIXTURE FOR DISPOSABLE DISHES-01NO.
		DISPOSABLE DISHES :50 NO.

RHEOLOGY SOFTWARE

	TEMPLATE BASED WITH ATLEAST 60 BUILT-IN TEMPLATES
ARCHITECHTURE	PRE-PROGRAMMED FOR ALL TYPES OF MATERIALS
	INTEGRATED MODELLING/CURVE FITTING, RHEO-OPTICS
	ADAPTER MODULE, SQUEEZE FLOW RHEOLOGY AND
ANALYSIS MODULES	EXTENSIONAL RHEOLOGY MODULES.
5	ROTATIONAL WITH RATE/CONTROL
	STRESS/COMBINATION OF CSR+CSS,
9	OSCILLATORY WITH STRAIN / DIRECT STRAIN AMPLITUDE /
"	CONTROL STRESS / COMBINATION OF TRUSTRAIN+CSS
	TRANSIENT WITH CREEP(SINGLE/MULTI-LEVEL)/STEP-
	STRAIN(STRESS RELAXATION)
	COMBINATION WITH ANY MODES ABOVE – FOR E.G.
	TRANSIENT+ROTATIONAL OR OSCILLATORY+ROTATIONAL
2	ELASTIC (G'), LOSS (G"), COMPLEX MODULUS (G*), TAN δ
	AS A FUNCTION OF TIME, TEMPERATURE, FREQUENCY,
	STRAIN AND STRESS IN SHEAR MODE.
	COMPLEX VISCOSITY AS A FUNCTION OF TIME,
a .	TEMPERATURE, FREQUENCY, STRAIN AND STRESS
	WINDUP TEST WITH PRESET WITH EXTENSIONAL RATE &
*	MEASUREMENT OF TENSILE STRAIN OR EXTENSIONAL
	VISCOSITY, FATIGUE TEST
	TEMPERATURE STABILITY, SHRINKAGE, ELONGATION,
	PHASE TRANSITIONS, SECONDARY RELAXATIONS &
	BRITTLENESS OF COATED OR LAMINATED FILMS
	ELASTIC(E'), LOSS(E"), COMPLEX MODULUS(E*), TAN δ AS
	A FUNCTION OF TIME, TEMPERATURE, FREQUENCY,
	STRAIN AND STRESS IN LINEAR MODE
	GLASS TRANSITION TEMPERATURE, ALPHA, BETA &
	GAMMA TRANSITIONS, CRYSTALLINE TEMPERATURE
	VISCO-ELASTIC PROPERTIES IN VARIATION TO
	TEMPERATURE /
	MAGNETO SWEEP IN LINEAR RANGE
TESTING PROTOCOLS	*
SUPER-IMPOSED	STEADY SHEAR OVER OSCILLATORY SIMULTANEOUS
TESTING	OPERATION
TITELL TELLEC	

UTILITIES

AIR COMPRESSOR	100PSI, 5CFM OILFREE
AIR DRYER	MULTISTAGE MEMBRANE TYPE WITH MICROFILTERS

Three Years Extended warranty should be quoted in the main quote.

mani quote.

IV. GROWTH CHAMBER TO BREED INSECTS- 4 Nos

1. IFT No. : IISER/PUR/7334/15

2. Due Date : 21st April 2016 [4 PM]

3. Date of Opening of : 22nd April2016 [3 PM]

TECHNICAL BID

4. DATE OF OPENING OF PRICE: Will be notified later.

BID

5. Cost of Tender# : Rs. 500 + 5% VAT

6. EMD [BID SECURITY] ** : Rs. 1,28,000/-

Specifications for Insect Growth Chambers

A mobile growth chamber is needed to breed insects throughout the entire life cycle including mating. The growth chambers should meet the following minimum specifications. The tender documents should include the detailed technical product brochure

- 1. Temperature range: ca. 4 42 °C with lights on, with accuracy of +/- 0.5°C
- 2. Humidity: 50 to 95%, with accuracy of +/- 2%
- 3. Programs: Ramping and non-ramping programs.
- 4. Lighting:
- a) Fullspectrum daylight mimicking lamps
- b) Light intensity 20,000 lux
- c) Uniform lighting from all directions
- d) Adjustable intensity
- e) Two vertical Light banks on the sides
- 5. Light banks should be separated by a barrier to minimize heat. The barrier should allow maximum light transmission while effectively minimizing heat. The material of this barrier should be clearly mentioned.
- 6. Adjustable shelf heights and at least 6 removable shelves.
- 7. Programmable circadian rhythm (day/night light regimes).
- 8. Phenolic coated coils.
- 9. Corrosion resistant interiors and exteriors (the material should be clearly mentioned in the offer).
- 10. Should have a future upgrade option of monitoring and controlling of chamber via internet
- 11. Control Panel should preferably have a touchscreen interface with access protected by password.
- 12. Audible alarms and visual indicators if temperature/humidity goes out of range. When the normal range is reached, the alarms should be turned off automatically.
- 13. User should preferably be able to set the threshold high and low temperature/humidity that sets off the alarm.
- 13. Roof mounted refrigeration system preferred
- 14. Working volume range: 800-1200 litres, but not less than 800 litres.
- 15. Warranty of three years, and an Annual Maintenance Contract (AMC) for a further 3 years. The AMC rates should be quoted separately.
- 16. Growth chambers will be initially installed in our transit location. The company should take responsibility for dismantling the growth chambers and reinstalling in the permanent location (Biological

Sciences Block, Vithura campus). An undertaking should be provided by the company regarding this.

17. The chamber should have a caster assembly, and should also

preferably have adjustable legs.

18. Mention the minimum number of months needed to deliver the product. The speed of delivery may be taken in account when choosing the company.

- 19. Mention at least ten R&D laboratories/institutions in India where you have supplied growth chambers that are being used currently, with contact details of concerned person in each institute. We may contact and/or visit these institutes to assess the quality of your product.
- 20. External locking mechanism should be provided.
- 21. Suitable stabilizers for each machine should be provided.
- 22. If an external water storage container is needed, it should be included.
- 23. Data loggers should be provided for each machine. These data loggers should store temperature, humidity and light intensity, at a frequency of 30 minutes (or better) for a minimum of 6 months, and the data should be retrievable to a computer.

24. Compliance sheet for all specifications should be attached. Wherever relevant, the appropriate section/page number of the technical

brochure should be cited.

TERMS&CONDITIONS

- 1) Bid with IFT No. & Item Name shall be quoted over cover
- 2) All the correspondence in this regard should be done in favour of Deputy Registrar (Purchase & Stores), Indian Institute of Science Education & Research Thiruvananthapuram, CET Campus, Engineering College P.O, Trivandrum 695016.
- 3) Instructions to Bidders [Annexure I] and General Terms and Conditions of the Contract [Annexure II] shall be followed.
- 4) Tender cost in the form of DD favouring IISERTVM shall be sent along with 'Technical bid'.
- 5) **Bid Security [refundable without any interest] shall be as per clause 1.15 of Annexure I and shall also be sent alongwith Technical bid. Incase the Bid security is provided by Bank Guarantee, specimen for the same is at Annexure IV.
- 6) Integrity Pact [Annexure III] shall be completed, signed, sealed and sent alongwith Technical Bid only for the Tender at Sl.No.1 of the INDEX.
- 7) Clause 1.10[Bid Form] of Annexure I is not applicable for this Tender.
- 8) <u>Tenders without Tender Cost, Integrity Pact [for Sl. No. I Index only) and Bid Security shall not be considered and summarily to be disqualified from participating tender.</u>
- 9) Tender Opening:

All tenders will be opened at Pratheeksha Building. Authorized representatives of the bidders may attend the Tender Opening only with authorization letters.

TWO - PART TENDER

PART I - TECHNICAL BID:

Consisting of all Technical details alongwith commercial terms and conditions. DD towards Tender Cost and Bid Security [EMD] signed shall be sent alongwith Technical bids, Clientele list and details of TWO major installations in India.

PART II - PRICE BID:

Showing item-wise prices for the items mentioned in the Technical Bid.

The technical bid and the Price bid should be in separate sealed and superscribed covers. Both these covers are to be put in a sealed bigger cover superscribing Tender No and due date. Technical bids will be opened first and after evaluation, price bids of only the shortlisted bidders will be opened.

DEPUTY REGISTRAR

उप कुलसचिव [क्रय एवं भंडार]
Deputy Registrar [Purchase & Stores]
भारतीय विज्ञान शिक्षा एंव अनुसंघान संस्थान तिरुवनन्तपुरम
Indian Institute of Science Education and Research Thiruvananthapuram
सी.ई.टी कैम्पस, इंजीनीयप्रीय कोलेज पी.ओ

CET Campus, Engg. College P.O. तिरुवनन्तपुरन/Thiruvananthapuram-695 016

INSTRUCTIONS TO BIDDERS

1.1. ELIGIBLE BIDDERS.

- 1.1.1 This Invitation for Bids is open to all suppliers.
- 1.1.2 Bidders should not be associated, or have been associated in the past, directly or indirectly, with a firm or any of its affiliates which have been engaged by the Purchaser to provide consulting services for the preparation of the design, specifications, and other documents to be used for the procurement of the goods to be purchased under this Invitation of Bids.

1.2. Cost of Bidding

1.2.1 The Bidder shall bear all costs associated with the preparation and submission of its bid, and "the Purchaser", will in no case be responsible or liable for these costs, regardless of the conduct oroutcome of the bidding process.

1.3. FRAUD AND CORRUPTION:

- 1.3.1 The purchaser requires that the bidders/suppliers and contractors observe the highest standardof ethics during the procurement and execution of such contracts.
- 1.3.2 The purchaser will reject a proposal for award if it determines that the Bidder recommendedfor award has, directly or through an agent, engaged in corrupt, fraudulent, collusive or coercivepractices in competing for the Contract in question;

 The Bidding Documents

1.4. Cost of Bidding Documents

1.4.1 Interested eligible bidders may download the document from our Website. However the bid document cost to be paid during the submission of the bid.

1.5. CONTENT OF BIDDING DOCUMENTS

- 1.5.1 The goods required, bidding procedures and contract terms are prescribed in the biddingdocuments which should be read in conjunction.
- 1.5.2 The Bidder is expected to examine all instructions, forms, terms, and specifications in thebidding documents. Failure to furnish all information required by the bidding documents or submission of a bid not substantially responsive to the bidding documents in every respect will be at the Bidder's risk and may result in rejection of its bid.

1.6. CLARIFICATION OF BIDDING DOCUMENTS

1.6.1 A prospective Bidder requiring any clarification of the Bidding Documents shall contact the Purchaser in writing via fax/email. The Purchaser will respond in writing to any request for clarification, provided that such request is received not later than ten (10) days prior to the deadline for submission of bids. The Purchaser shall forward copies of its response to all those who have acquired the Bidding Documents directly from it, including a description of the inquiry but without identifying its source. Should the Purchaser deem it necessary to amend the Bidding Documents as a result of aclarification, it shall do so following the procedure under clause relating to amendment of Bidding documents and Clause relating to Deadline for Submission of Bids. The clarifications and amendments issued would also be hosted on the website of the purchaser for the benefit of theother prospective bidders.

1.7. AMENDMENT OF BIDDING DOCUMENTS

- 1.7.1 At any time prior to the deadline for submission of bids, the Purchaser may, for any reason, whether at its own initiative or in response to a clarification requested by pa prospective bidder, modify the bidding documents by amendment.
- 1.7.2 All prospective bidders who have received the bidding documents will be

ela de la constante de la cons

- notified of theamendment in writing or by e-mail and will be binding on them. The samewould also be hosted on the website of the purchaser and all prospective bidders are expected tosurf the website before submitting their bids to take cognizance of the amendments.
- 1.7.3 In order to allow prospective bidders reasonable time to take the amendment into account, while in preparing their bids, the Purchaser, at its discretion, may extend the deadline for the submission of bids and host the changes on the website of the purchaser.
- 1.7.4 In case of any amendment to the bid, it will be done at least 7 days before due date and will be published in website. Bidders are required to keep this in view before submission. Normally extension of due date will not be entertained. However in special cases if due date is extended, it will be notified under the same tender notice before 3 days of due date.

PREPARATION OF BIDS

1.8. LANGUAGE OF BID

- 1.8.1 The bid prepared by the Bidder, as well as all correspondence and documents relating to thebid exchanged by the Bidder and the Purchaser, shall be written in English language onlyespecially when the details are technical.
 - However of GOI makes it mandatory under Rajbhasha Abhniyam in that case views of Rajbashaunit of IISER-TVM may be sought.
- 1.8.2 The Supplier shall bear all costs of translation, if any, to the English language and all risks of the accuracy of such translation, for documents provided by the Supplier.

1.9. DOCUMENTS COMPRISING THE BID

- 1.9.1 The bid prepared by the Bidder shall include:
 - a) Bidder Information
 - b) Bid security as specified in the Invitation to Bids.
 - c) Service support details
 - d) Deviation Statement if any.
 - e) Performance Statement.
 - f) Manufacturer's Authorization.
 - g) Documentary evidence establishing that the bidder is eligible to bid and is qualified to perform the contract if its bid is accepted.
 - h) Bid form.
 - i) Documents establishing goods eligibility and conformity to bidding documents.
 - j) Applicable Price Schedule Form.
 - k) DGS&D Registration certificate in case the items under procurement falls under the restricted category of the current export-import policy of the Govt. of India.

1.10. BID FORM AND PRICE SCHEDULE

1.10.1 The bidder shall complete the Bid with the appropriate price schedule.

1.11. BID PRICES

- 1.11.1 The Bidder shall indicate on the appropriate price schedule, the unit prices and total bidprices of the goods it proposes to supply under the contract.
- 1.11.2 Prices indicated on the price-schedule form shall be entered separately in the followingmanner:

(A) FOR GOODS MANUFACTURED WITHIN INDIA

- (i) The price of the goods quoted Ex-works including taxes already paid.
- (ii) VAT and other taxes like excise duty etc[shall be shown extra] which will be payable on the goods if the contract isawarded.

omraet isawarded.